

General Description

The MAX3677 evaluation kit (EV kit) is an assembled demonstration board that provides convenient evaluation of the MAX3677 low-jitter, precision clock generator. The EV kit includes an on-board 25MHz crystal to allow for immediate testing.

The EV kit includes switches to allow easy selection of different modes of operation. The clock outputs use SMA connectors and are AC-coupled to simplify connection to test equipment.

Features

- ◆ AC-Coupled I/Os for Ease of Testing
- ◆ Fully Assembled and Tested
- ♦ +3.3V Power-Supply Operation
- ♦ On-Board 25MHz Crystal

Ordering Information

PART	TYPE
MAX3677EVKIT+	EV Kit

⁺Denotes lead(Pb)-free and RoHS compliant.

Component List

DESIGNATION	QTY	DESCRIPTION
C1	1	2.2µF ±10% ceramic capacitor (0805)
C2, C4, C5, C9, C11–C15, C20, C44, C54–C64, C66, C67	24	0.1µF ±10% ceramic capacitor (0402)
СЗ	1	33μF ±10% Tantalum capacitor (B case)
C6, C21	2	0.01µF ±5% ceramic capacitor (0402)
C7	1	10µF ±20% ceramic capacitor (0603)
C17	1	3pF ±5% ceramic capacitor (0402)
C45	1	27pF ±5% ceramic capacitor (0402)
C46	1	33pF ±5% ceramic capacitor (0402)
J4, J8, J10	3	2-pin header, 0.1in centers
J13	1	SMA right-angle connector
J14	1	SPDT switch
J15, J16, J35, J36, J44, J51, J52, J55, J56, J59–J62, J65, J66	15	SMA connectors

DESIGNATION	QTY	DESCRIPTION
L1	1	4.7µH inductor (DS1608)
R1, R89	2	49.9Ω ±1% resistor (0402)
R2	1	Do not install (0402)
R3	1	0Ω ±5% resistor (0402)
R34	1	10.5Ω ±1% resistor (0402)
R87, R90	2	806Ω ±1% resistor (0402)
R88	1	33.2Ω ±1% resistor (0402)
SW3	1	SP3T switch
TP1, TP2, TP3, TP5, TP26, TP28, J2, J48	8	Test points
U6	1	+3.3V, low-jitter, precision clock generator (32 TQFN-EP*) MAX3677CTJ+
Y1	1	25MHz crystal NDK America EXS00A-AT00429
_	3	Shunts
_	1	MAX3677 EVKIT BOARD + REV A

^{*}EP = Exposed pad.

Component Suppliers

SUPPLIER	PHONE	WEBSITE
NDK America	815-544-7900	www.ndk.com/en

Note: Indicate that you are using the MAX3677 when contacting these component suppliers.

Quick Start

For evaluation of the MAX3677, configure the EV kit as follows:

- 1) Determine which output is going to be evaluated and connect to the test equipment through SMA cables. Be sure not to leave any outputs unterminated, i.e., place 50Ω terminators on all unused outputs.
- 2) Set PLL_BP high so that the on-board crystal is used.
- 3) Place a shunt on J8 (VDD_DIFF) and J10 (VDD_SE) to connect the power supply for the differential and single ended outputs.
- 4) Connect a +3.3V power supply to J48 (VCC) and J2 (GND). Set the current limit to 200mA.

Adjustment and Control Descriptions (see Quick Start first)

COMPONENT	NAME	FUNCTION
J4	INDUCTOR SHUNT	J4 shunts the power-supply inductor. Normal operation is J4 not shunted.
J8	VDD_DIFF	Connects the power supply for the Q0, Q1, Q2, Q3, Q4, Q5, and Q6 clock outputs to the VCC supply.
J10	VDD_SE	Connects the power supply for the Q7 clock output to the VCC supply.
J14	OE	When set to HIGH, the Q4, Q5, and Q6 outputs are enabled. When set to LOW, the Q4, Q5, and Q6 outputs are disabled.
SW3	PLL_BP	When set to HIGH, the PLL locks to the crystal interface (25MHz at X_IN and X_OUT). When set to OPEN, the PLL locks to the OSC_IN input (25MHz typical). When set LOW, the PLL is bypassed and the OSC_IN input is selected. When bypass mode is selected, the VCO/PLL is disabled to save power and eliminate intermodulation spurs.

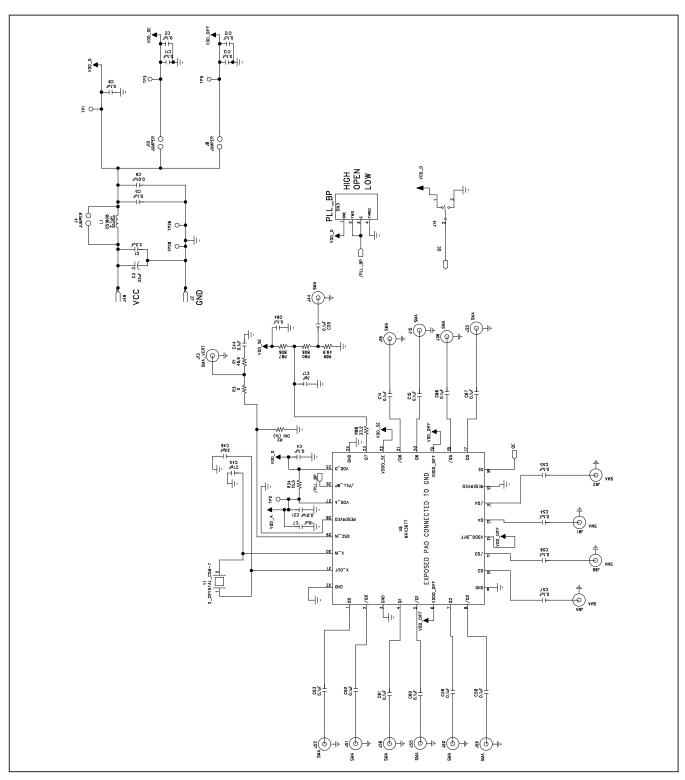


Figure 1. MAX3677 EV Kit Schematic

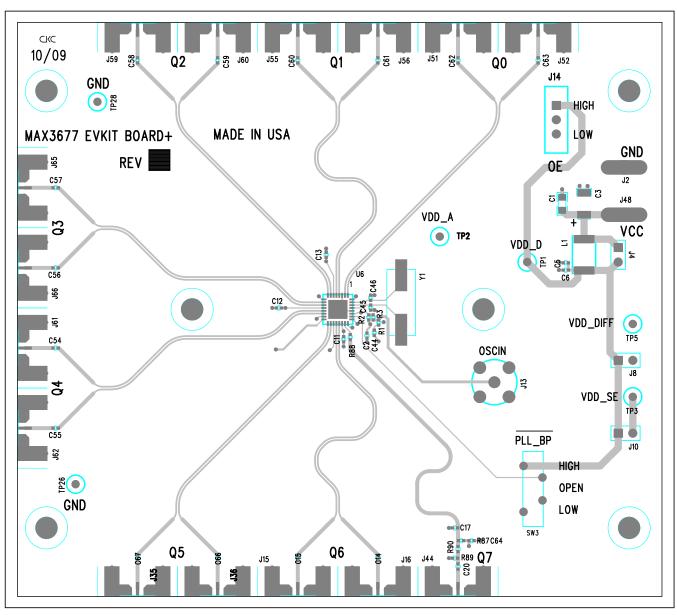


Figure 2. MAX3677 EV Kit Component Placement Guide—Component Side

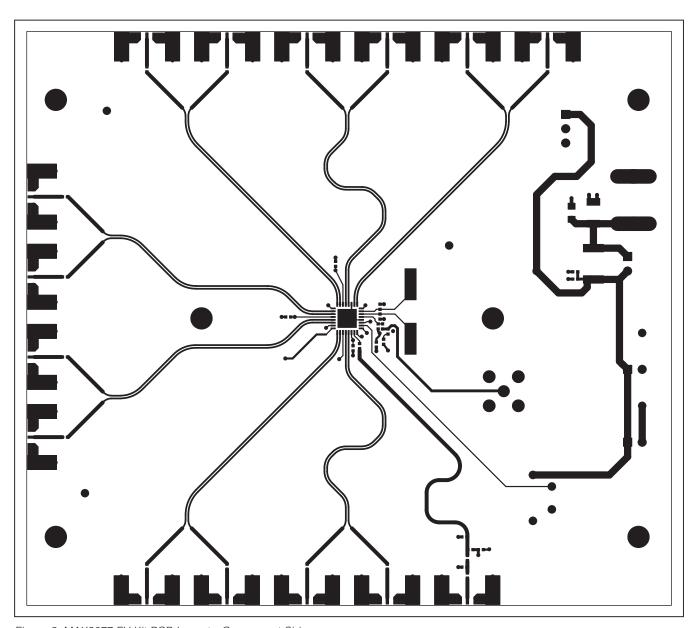


Figure 3. MAX3677 EV Kit PCB Layout—Component Side

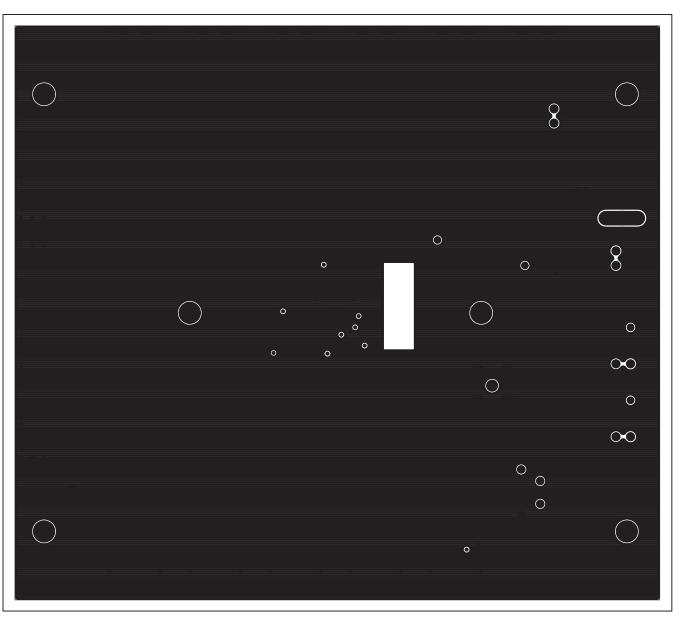


Figure 4. MAX3677 EV Kit PCB Layout—Ground Plane

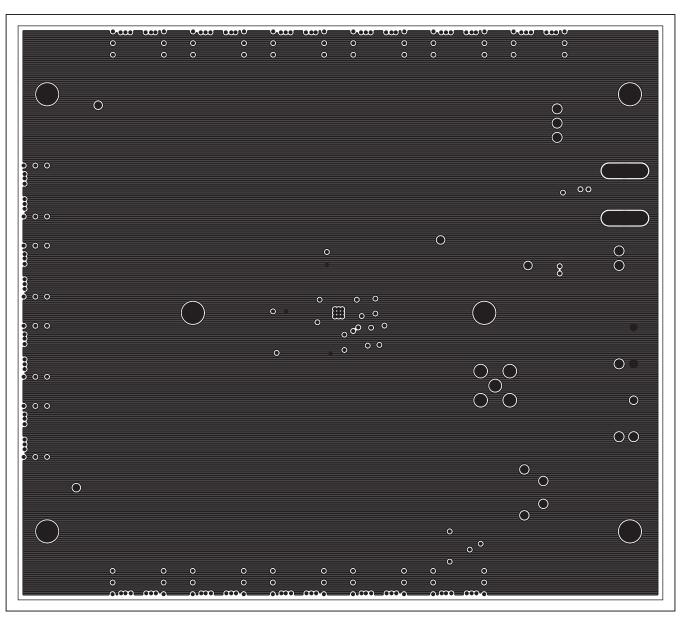


Figure 5. MAX3677 EV Kit PCB Layout—Power Plane

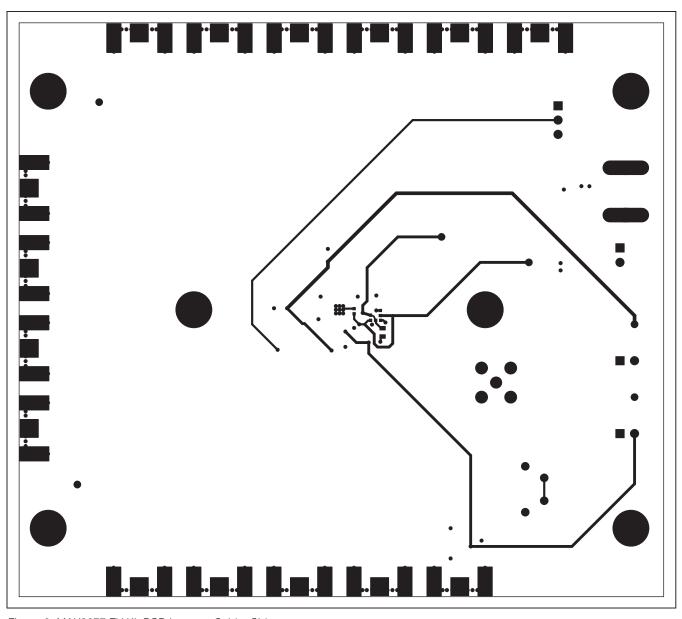


Figure 6. MAX3677 EV Kit PCB Layout—Solder Side



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